Engineering Product Specification

F1206-Series

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Rev. #	Revision Description	Date	Author	Appr.
А	Original	3/26'07	SEA	C. X. M.
В	Add Application; Update UL No.; Correct Interrupting Rating.	8/22'08	Jesse	SEA
С	Add Halogen-free; Update Interrupting Rating from 35A to 50A; Add p/n "F1206-6.0A".	9/25'08	Jesse	SEA
D	Update Item 2、Item 9.	11/5'08	Jesse	SEA
E	Update IT curve & I ² t curve.	11/25'08	Jesse	SEA
F	Update Cold Resistance & Electrical Characteristics	1/06'09	Jesse	Alan
G	Update Cold Resistance & Electrical Characteristics	7/15'09	Rock	Alan



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1. Scope

This Specification applies to F1206 series SMD fuses.

2. General

- Fast acting
- RoHS compliant
- Halogen-free
- 3.1mm×1.55mm physical size
- Thick film manufacturing method, ceramic substrate, silver fusing element
- Higher temperature profiles
- Excellent environmental integrity

3. Manufacturer and Production Facility

Manufacturer

Nanjing Sinochip Technology & development Co.,

Ltd. Qingma Road 6#

Maqun Science & Technology Park

Nanjing City, Jiangsu Province, P. R. China

Phone: 086-25-52153380 Fax: 086-25-52157065

4. Agency / Certificate Information

• UL Recognition Card:

JDYX2.E319540, JDYX8.E319540

ISO 9001:2000, Certificate Number 10807Q10334ROS



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5. Catalog Symbol

Example F1206-1.0A

<u>F</u> <u>1206-1.0A</u>

1 2 3

①. Symbol of Sinochip Electrical Characteristic: F = Fast acting

②. Size Number

③. Ampere Rating: 1A

6. Ordering Information

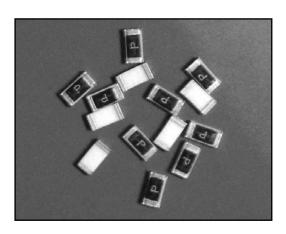
Part Number	Mark	Current Rating (A)	Voltage Rating (V)	Interrupting Rating 32V DC	Typical Cold DCR [*] (Ω)	Nominal I ² T** (A ² S)
F1206-0.5A	F	0.50	32	50A	1.375	0.0155
F1206-0.75A	G	0.75	32	50A	0.605	0.0267
F1206-1.0A	Н	1.00	32	50A	0.270	0.0279
F1206-1.5A	K	1.50	32	50A	0.130	0.0491
F1206-2.0A	N	2.00	32	50A	0.074	0.1251
F1206-2.5A	О	2.50	32	50A	0.051	0.1255
F1206-3.0A	P	3.00	32	50A	0.033	0.1350
F1206-3.15A	R	3.15	32	50A	0.030	0.1490
F1206-3.5A	R	3.50	32	50A	0.0325	0.1948
F1206-4.0A	S	4.00	32	35A	0.021	0.3025
F1206-5.0A	Т	5.00	32	35A	0.0165	0.5207
F1206-6.0A	6	6.00	32	35A	0.0145	0.8134
F1206-7.0A	U	7.00	32	35A	0.0085	4.0418

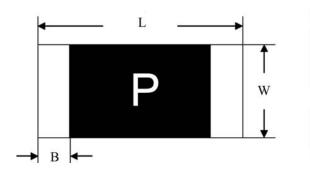
Measured at $\leq 10\%$ rated current and 25 °C. Melting I²T at 10 times of rated current.

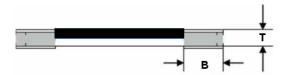


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7. Shape & Dimensions: (mm)





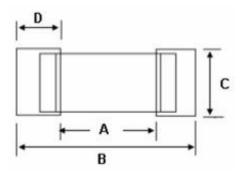


L W		T	В
3.10±0.20	1.55±0.20	0.55±0.20	0.40±0.10



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8. Recommended Land Patterns: (mm)



Α	В	С	D
2.1±0.3	4.7±0.5	1.5±0.3	1.5±0.3

9. Materials:

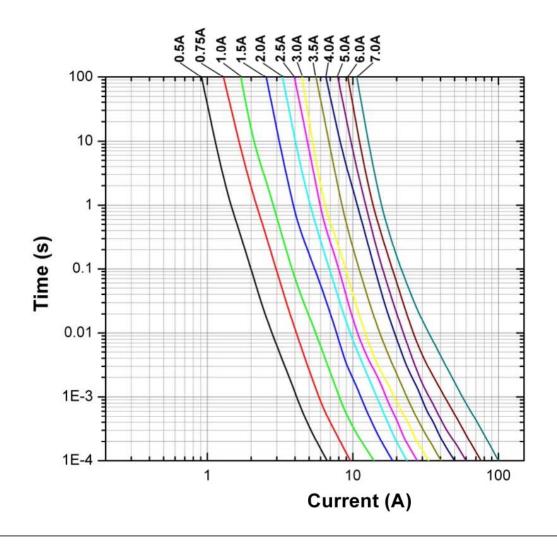
	Components	Material
1	Substrate	Ceramic
2	Terminations	Silver over-plated with tin (100%)
3	Element	Silver or Silver/palladium



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10. Time Current Curve:

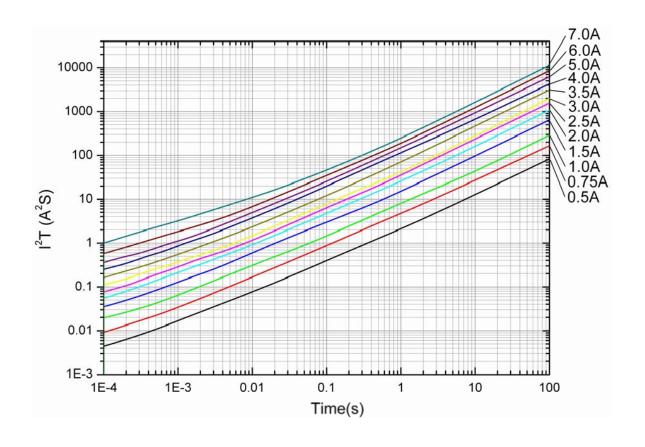
Electrical Characteristics					
Ampere Rating	Opening Time				
500mA-7A	100%	4 Hours Min.			
500mA-7A	200%	60 Seconds Max.			
500mA-7A	250%	5 Seconds Max.			





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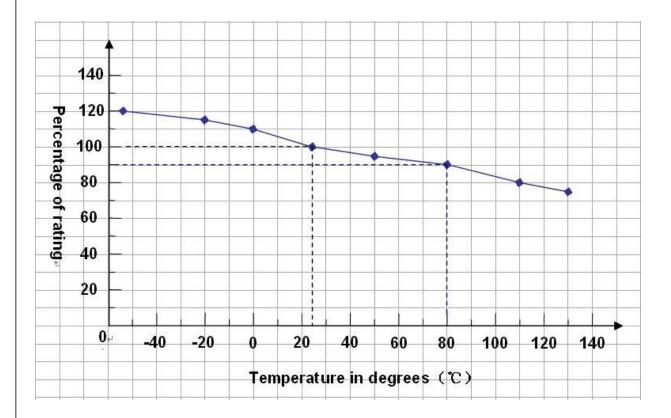
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- 12. Temperature Derating Curve: (Ambient temperature on current-carrying capacity)
- For Circuit, current rating shall be derated in accordannce with the figure.
- This current derating curve is for fusing characterisics.

Example,

Work Temp:80°C, Temp derating factor = 90%

Melting
$$I^2t_{fuse} \ge I^2t_{pulse}/ Fp / 0.9$$





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13. Reliability Test:

Characteristics	Test condition / Methods	Requirement	Test Reference	
Carrying capacity 100% of its rated current		No Fusing,4hr min	Refer to SINOCHIP File	
Fusing Time	200% of its rated current	Within 60sec	Refer to SINOCHIP File	
	250% of its rated current	Within 5sec	Refer to SINOCHIP File	
Solderability	235°C±5°C, 3s±0.5s	95% coverage min	IEC60127/A.3.3; IEC60068-2-20; MIL-STD-202 Method 208H	
Resistance to soldering	260°C±5°C, 10s±0.5s	△R:<10%	MIL-STD-202 Method 210	
Bending test	Distance between holding points: 90mm, Bending: 1mm, 1time, 10sec	(1) No mechanical damages(2) △R: <10%	Refer to SINOCHIP File	
High Temperature Operating Life	96hours, 125°C at 60% rated current. Measure cold resistance and Time-Current characteristics.	(1)△R: <10%; (2)100% of Rating Current, Opening time >4 hours (3)200% of Rating Current, Opening time <60 seconds	MIL-STD-202 Method 108	
Moisture Resistance	10 Cycles. Measure cold resistance and Time-Current characteristics.	(1)△R: <10%; (2)100% of Rating Current, Opening time >4 hours (3)200% of Rating Current, Opening time <60 seconds	MIL-STD-202 Method 106	
High Temperature Exposure	1000 hrs. @ T=125°C. Unpowered. Measure cold resistance. and Time-Current characteristics.	(1)△R: <10%; (2)100% of Rating Current, Opening time >4 hours (3)200% of Rating Current, Opening time <60 seconds	MIL-STD-202 Method 108	
Insulation Resistance	DC resistance	$0.1 \mathrm{M}\Omega$ min	IEC60127-4	
ON /OFF Cycle Test	Surge current and 100% rated current; 50s ON; 10s OFF; 100,000 Cycles	(1)No open; (2)100% of Rating Current, Opening time >4 hours (3)200% of Rating Current, Opening time <60 seconds	Refer to SINOCHIP File	



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Salt spray 5% salt solution, 48 hours exposure		△R: <10%	MIL-STD-202 Method 101	
Thermal Shock 10 cycles between -55°C/+125°C, 30 minutes @each extreme		No mechanical damage; △R: <10% IEC 60068-2-14		
Interrupting Ability Loading current 50A		without permanent arcing,ignition and bursting of fuse link	UL248-14	

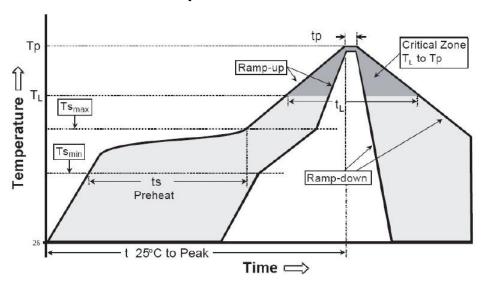
14. Recommended Solder Curve:

14.1 Infrared Reflow

14.1.1 Temperature:260°C

14.1.2 Time:30 Seconds Maximum

14.1.3 Recommend Reflow profile



Profile Feature	Pb-Free Assembly
Average Ramp-Up Rate(Ts _{max} to Tp)	3°C/second max.
Preheat Temperature Min(Ts _{min}) Temperature	150℃
Max(Ts _{max}) Time(Ts _{min} to Ts _{max})	200°C 60-120 seconds
Peak Temperature(Tp)	260 ℃
Time within 5°C of actual Peak Temperature(Tp)	20-40 seconds
Ramp-Down Rate	6°C/second max.
Time 25℃ to Peak Temperature	8 minutes max.



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14.2 Wave soldering

14.2.1 Reservoir Temperature:260 °C

14.2.2 Time in Reservior:10 Seconds Maximum

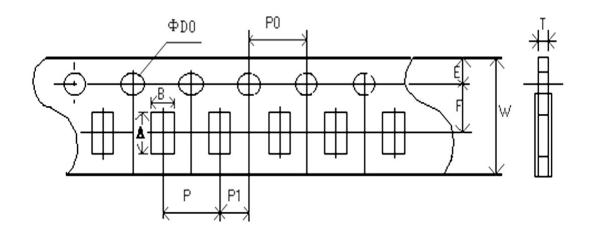
14.3 Hand Soldering

14.3.1 Temperature:380°C

14.3.2 Time:5 Seconds Maximum

15. Packaging:

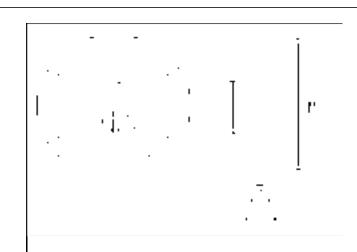
• 5,000 pieces of fuses in paper taper and reeled on a 178mm(7 inch) reel.



Туре	A	В	W	F	E
F1206	3.50 ±0.20	1.90 ±0.20	8.00 ±0.20	3.50 ±0.05	1.75 ±0.10
Туре	P	P0	P1	D0	Т



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Туре	M	W	Т	A	В	C	D
F1206	178	10.0	12.0	2.5	13.0	31.0	80.0
	±2.0	±1.5	±2.0	±0.5	±0.5	±1.0	±1.0

16. Storage:

- The maximum ambient temperature shall not exceed 40° C. Storage temperature higher than 40° C could result in the deformation of packaging materials.
- The maximum relative humidity recommended for storage is 65%. High humidity with high temperature can accelerate the oxidation of the solder plating on the termination and reduce the solderability of the components.
- Sealed plastic bags with desiccant shall be used to reduce the oxidation of the termination and shall only be opened prior to use. The products shall not be stored in areas where harmful gases containing sulfur or chlorine are present.

17. Application:

- Battery pack
- PC related equipment and peripherals(Hard drive, Printer, etc.)
- Portable devices(Mobile phone,PDA battery charger,etc.)
- Digital camera(Digital still camera)
- Game equipment
- LCD monitor,LCD modules
- Wireless basestation

END